



PATENT  
Atty. Dkt. No.: 25611-000011/US/DVA

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application No.: 09/827,112

Confirmation No.: 4932

Filing Date: April 5, 2001

Group Art Unit: 2827

Applicant: Sung Dae CHO

Examiner: J. Alcala

Title: REEL-DEPLOYED PRINTED CIRCUIT BOARD AND  
METHOD FOR MANUFACTURING CHIP-ON-BOARD  
PACKAGES

**PRELIMINARY AMENDMENT UNDER 37 C.F.R §1.114**

Hon. Commissioner of Patents and Trademarks  
Washington, D.C. 20231

February 5, 2003

Sir:

Concurrent with the filing of this Rule 1.114 Request for Continuing Examination, and in reply to the Office Action dated November 5, 2002, the following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

**IN THE SPECIFICATION:**

On page 1, line 3, prior to "BACKGROUND, please insert the following new paragraph:

**-CROSS-REFERENCE TO RELATED CASES**

This application is a divisional of U. S. Patent Application No. 09/219,407, filed December 23, 1998, now U.S. Patent No. 6,235,555, the contents of which is incorporated herein in its entirety by reference.--

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